



flowANPC S3 split

950 V / 600 A

Topology features

- Advanced Neutral Point Clamped topology
- Split topology
- Temperature sensor

Component features

- Low collector emitter saturation voltage
- High speed and smooth switching

Housing features

- Base isolation: AlN
- CTI600 housing material
- Compact, baseplate-less housing
- VINcoPress Technology
- Thermo-mechanical push-and-pull force relief
- Press-fit pin
- Reliable cold welding connection

Extra features

- Heat-Pipe and Heat-Sink optimized layout

Target applications

- Energy Storage Systems
- Solar Inverters

Types

- B0-SP10NAD600S704-PE19F18T
- B0-SP10NAE600S704-PE29F18T

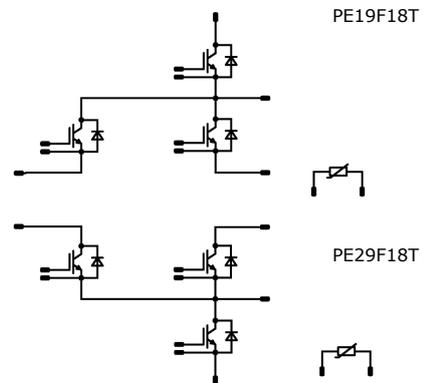
flow S3 12 mm housing



PE19F18T

PE29F18T

Schematic



**Maximum Ratings** $T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
AC Switch				
Collector-emitter voltage	V_{CES}		950	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	461	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	800	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	599	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	°C

AC Diode

Peak repetitive reverse voltage	V_{RRM}		950	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	191	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	600	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	365	W
Maximum junction temperature	T_{jmax}		175	°C

Neutral Point Switch

Collector-emitter voltage	V_{CES}		950	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	282	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	800	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	539	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	°C



Maximum Ratings

 $T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
DC-Link Diode				
Peak repetitive reverse voltage	V_{RRM}		950	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	191	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	600	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	365	W
Maximum junction temperature	T_{jmax}		175	°C

DC-Link Switch

Collector-emitter voltage	V_{CES}		950	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	382	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	1200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	704	W
Gate-emitter voltage	V_{GES}		±20	V
Maximum junction temperature	T_{jmax}		175	°C

Neutral Point Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	171	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	728	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 110\text{ °C}$	880	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	431	W
Maximum junction temperature	T_{jmax}		175	°C



Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6800	V
Creepage distance			>12,7	mm
Clearance		B0-SP10NAD600S704-PE19F18T B0-SP10NAE600S704-PE29F18T	11,99 11,39	mm
Comparative Tracking Index	CTI		≥ 600	

*100 % tested in production



Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

AC Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0065	25	4,15	4,85	5,65	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		400	25 125 150		1,21 1,23 1,24	1,4 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	950		25			8	μA
Gate-emitter leakage current	I_{GES}		20	0		25			200	nA
Internal gate resistance	r_g							0,75		Ω
Input capacitance	C_{ies}							49200		pF
Output capacitance	C_{oes}	$f = 100$ kHz	0	25		25		530		pF
Reverse transfer capacitance	C_{res}							220		pF
Gate charge	Q_g		±15		0	25		4100		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,16		K/W
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AC Diode

Static

Forward voltage	V_F				300	25 125 150	2,1	2,59 2,43 2,37	2,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 950$ V				25			12	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,26		K/W
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Vincotech

B0-SP10NAD600S704-PE19F18T
B0-SP10NAE600S704-PE29F18T
 datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Neutral Point Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0065	25	4,35	5,1	5,85	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		400	25 125 150		1,82 2,07 2,13	2,25 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	950		25			8	μA
Gate-emitter leakage current	I_{GES}		20	0		25			200	nA
Internal gate resistance	r_g							0,75		Ω
Input capacitance	C_{ies}							25200		pF
Output capacitance	C_{oes}	$f = 100$ kHz	0	25		25		540		pF
Reverse transfer capacitance	C_{res}							80		pF
Gate charge	Q_g		±15		0	25		900		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,18		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		207,36 211,69 213,64		ns
Rise time	t_r	$R_{gon} = 2$ Ω $R_{goff} = 2$ Ω				25 125 150		36,11 38,61 39,6		ns
Turn-off delay time	$t_{d(off)}$		±15	600	355	25 125 150		176,43 210,44 220,65		ns
Fall time	t_f					25 125 150		26,39 46,75 56,01		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD} = 1,08$ μC $Q_{tFWD} = 1,11$ μC $Q_{tFWD} = 1,12$ μC				25 125 150		7,81 7,54 7,55		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		12,45 17,92 20,04		mWs



Vincotech

B0-SP10NAD600S704-PE19F18T
B0-SP10NAE600S704-PE29F18T
 datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
DC-Link Diode										
Static										
Forward voltage	V_F				300	25 125 150	2,1	2,59 2,43 2,37	2,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 950$ V				25			12	μA
Thermal										
Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,26		K/W
Dynamic										
Peak recovery current	I_{RM}	$di/dt=6618$ A/μs $di/dt=5990$ A/μs $di/dt=6156$ A/μs	±15	600	355	25 125 150		69,54 69,01 68,97		A
Reverse recovery time	t_{rr}					25 125 150		25,67 26,2 26,4		ns
Recovered charge	Q_r					25 125 150		1,08 1,11 1,12		μC
Reverse recovered energy	E_{rec}					25 125 150		0,411 0,425 0,431		mWs
Peak rate of fall of recovery current	$(di_r/dt)_{max}$					25 125 150		7251,59 7000,21 6801,22		A/μs



Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	

DC-Link Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00975	25	4,35	5,1	5,85	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		600	25 125 150		1,82 2,07 2,13	2,25 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	950		25			12	μA
Gate-emitter leakage current	I_{GES}		20	0		25			300	nA
Internal gate resistance	r_g							0,5		Ω
Input capacitance	C_{ies}							37800		pF
Output capacitance	C_{oes}	$f = 100$ kHz	0	25		25		810		pF
Reverse transfer capacitance	C_{res}							120		pF
Gate charge	Q_g		±15		0	25		1350		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,14		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		207,36 211,69 213,64		ns
Rise time	t_r					25 125 150		36,11 38,61 39,6		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		176,43 210,44 220,65		ns
Fall time	t_f					25 125 150		26,39 46,75 56,01		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD} = 0,395$ μC $Q_{tFWD} = 0,43$ μC $Q_{tFWD} = 0,469$ μC				25 125 150		7,81 7,54 7,55		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		12,45 17,92 20,04		mWs



Vincotech

B0-SP10NAD600S704-PE19F18T
B0-SP10NAE600S704-PE29F18T
 datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
Neutral Point Diode										
Static										
Forward voltage	V_F				160	25 125 150		1,72 2,17 2,32	1,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V				25		280	1600	μA
Thermal										
Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 5,2$ W/mK (PTM)						0,22		K/W
Dynamic										
Peak recovery current	I_{RM}					25 125 150		69,54 69,01 68,97		A
Reverse recovery time	t_{rr}					25 125 150		25,67 26,2 26,4		ns
Recovered charge	Q_r	$di/dt=6618$ A/μs $di/dt=5990$ A/μs $di/dt=6156$ A/μs	±15	600	355	25 125 150		0,395 0,43 0,469		μC
Reverse recovered energy	E_{rec}					25 125 150		0,106 0,12 0,14		mWs
Peak rate of fall of recovery current	$(di_r/dt)_{max}$					25 125 150		7251,59 7000,21 6801,22		A/μs



Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	V_{CE} [V]	T_j [°C]	Min	Typ	Max	

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R100	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1 \%$						3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1 \%$						4000		K
Vincotech Thermistor Reference									I	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.

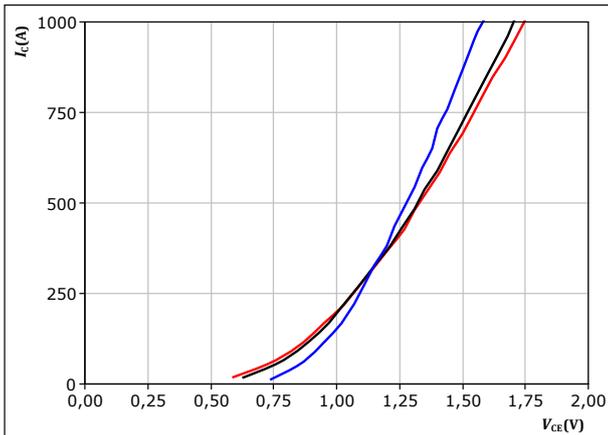


AC Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



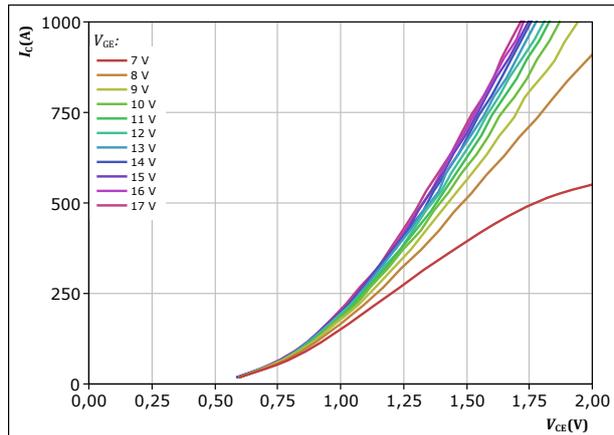
$t_p = 250 \mu s$
 $V_{GE} = 15 V$

T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

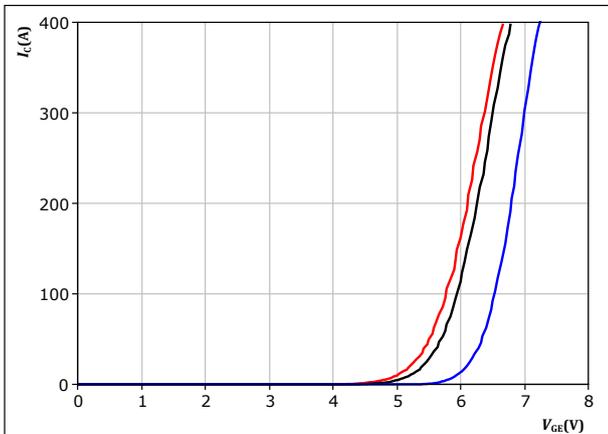


$t_p = 250 \mu s$
 $T_j = 150 \text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



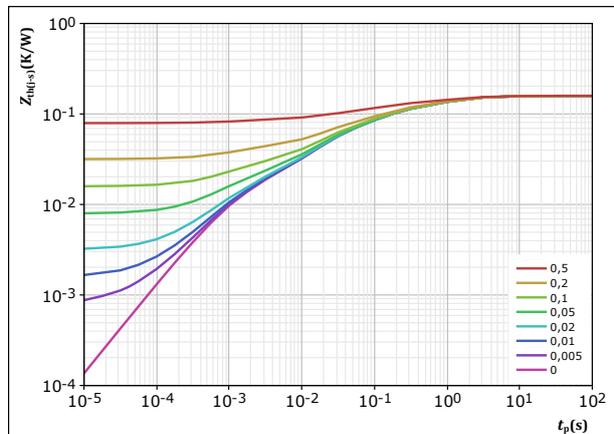
$t_p = 250 \mu s$
 $V_{CE} = 10 V$

T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,158 \text{ K/W}$

IGBT thermal model values

R (K/W)	τ (s)
9,88E-03	4,48E+00
4,29E-02	9,18E-01
5,31E-02	1,30E-01
4,03E-02	2,06E-02
1,24E-02	1,11E-03

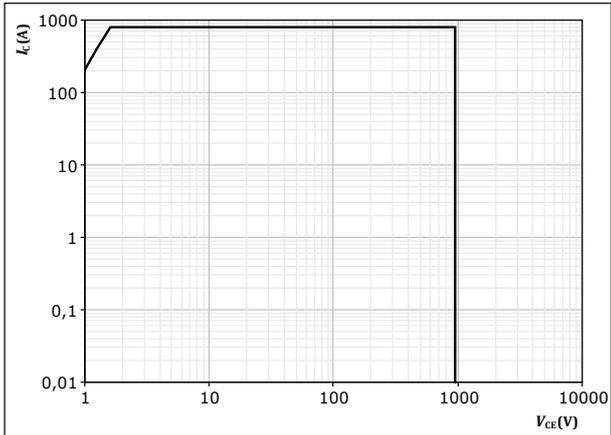


AC Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse

$T_s = 80$ °C

$V_{CE} = 15$ V

$T_j = T_{jmax}$



AC Diode Characteristics

figure 6. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

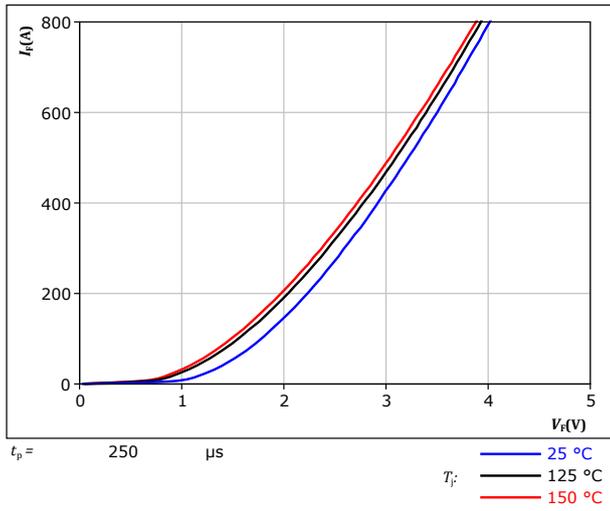
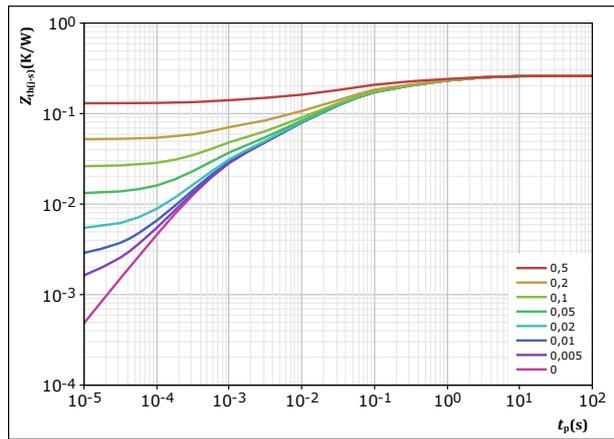


figure 7. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,26 \text{ K/W}$
 FWD thermal model values

R (K/W)	τ (s)
2,71E-02	2,94E+00
5,54E-02	5,40E-01
1,05E-01	5,17E-02
4,70E-02	7,63E-03
2,60E-02	6,45E-04

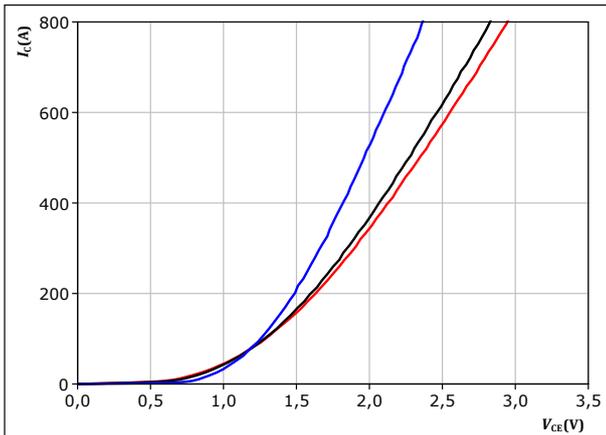


Neutral Point Switch Characteristics

figure 8. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



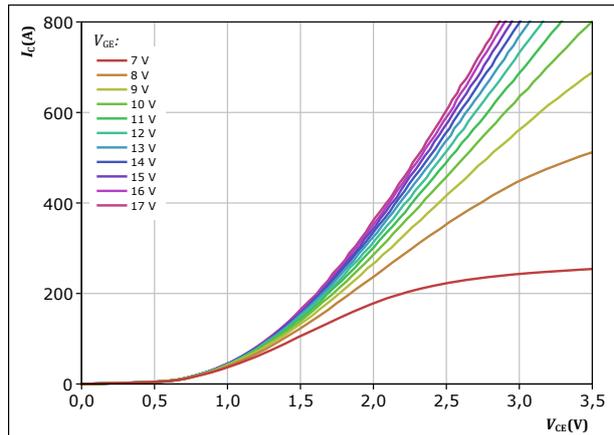
$t_p = 250 \mu s$
 $V_{GE} = 15 V$

$T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 9. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

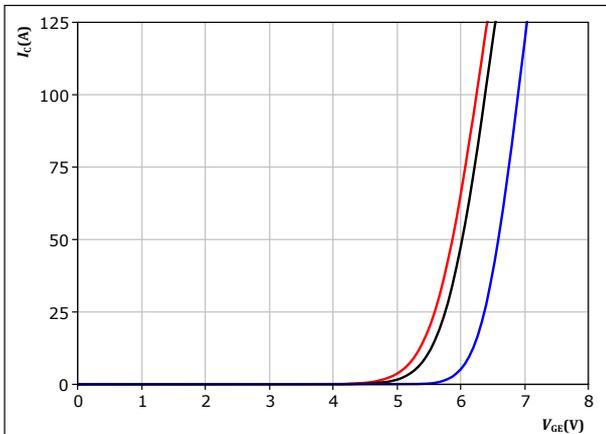


$t_p = 250 \mu s$
 $T_j = 150 \text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 10. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



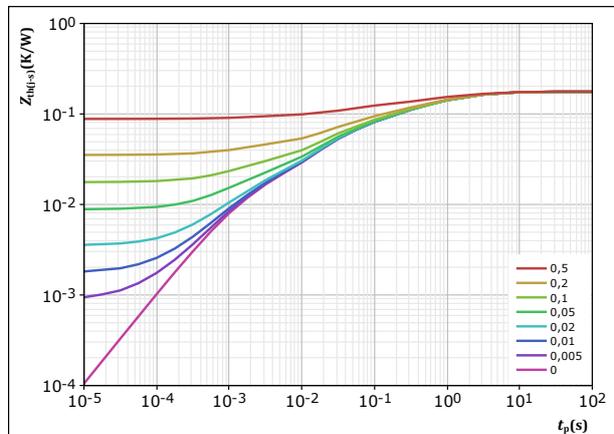
$t_p = 250 \mu s$
 $V_{CE} = 24 V$

$T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 11. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,176 \text{ K/W}$

IGBT thermal model values

R (K/W)	τ (s)
1,35E-02	5,32E+00
4,39E-02	1,45E+00
5,74E-02	2,58E-01
4,99E-02	2,79E-02
1,17E-02	1,38E-03

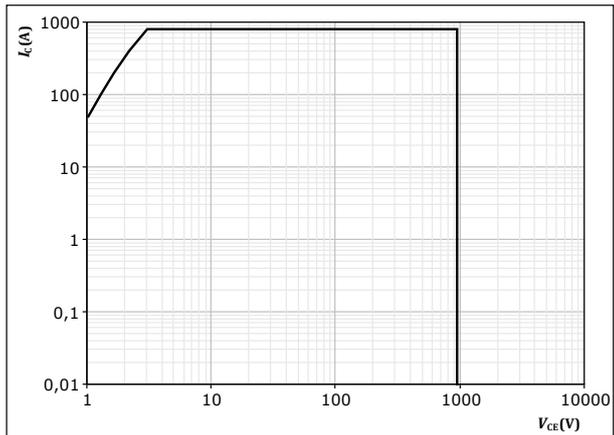


Neutral Point Switch Characteristics

figure 12. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse

$T_s = 80$ °C

$V_{CE} = 15$ V

$T_j = T_{jmax}$



DC-Link Diode Characteristics

figure 13. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

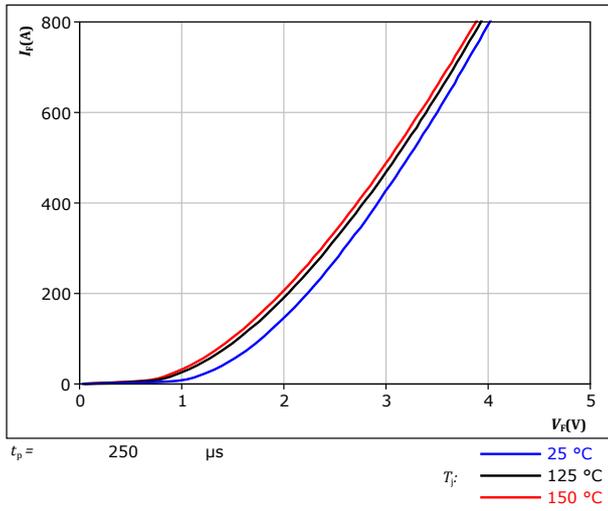
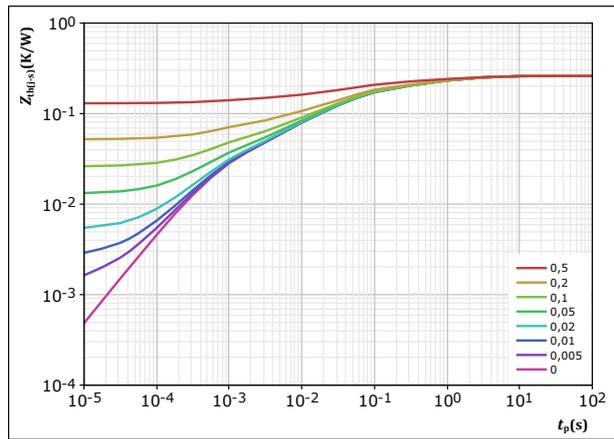


figure 14. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,26 \text{ K/W}$
 FWD thermal model values

R (K/W)	τ (s)
2,71E-02	2,94E+00
5,54E-02	5,40E-01
1,05E-01	5,17E-02
4,70E-02	7,63E-03
2,60E-02	6,45E-04

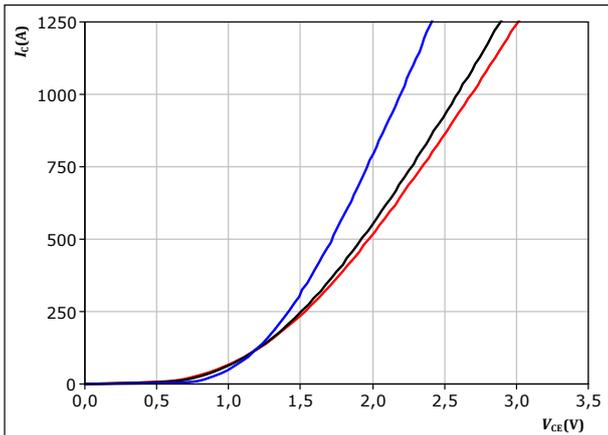


DC-Link Switch Characteristics

figure 15. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



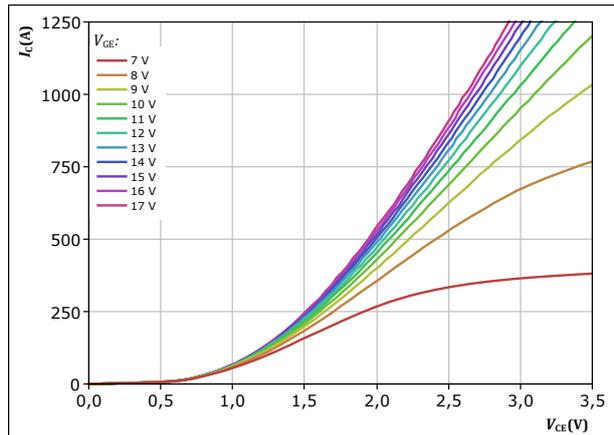
$t_p = 250 \mu s$
 $V_{GE} = 15 V$

$T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 16. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

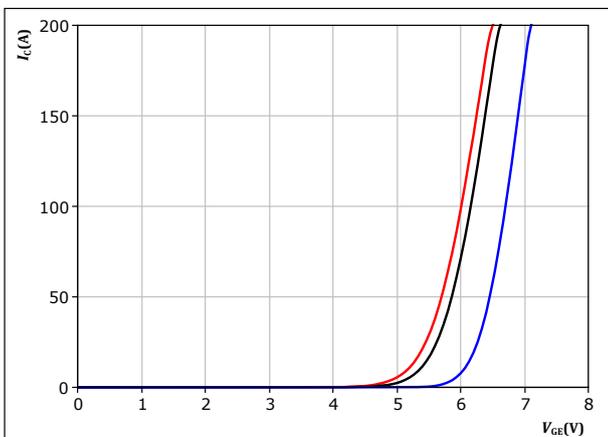


$t_p = 250 \mu s$
 $T_j = 150 \text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 17. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



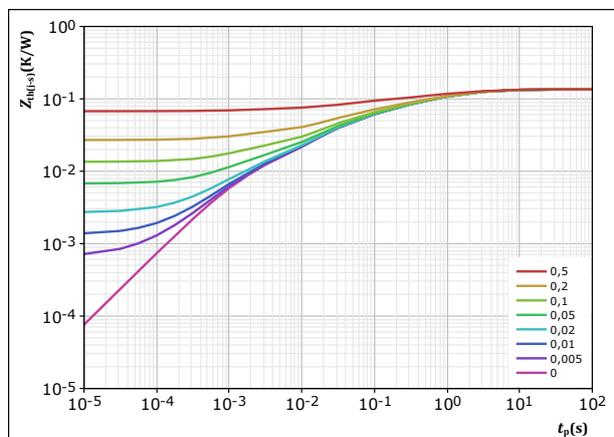
$t_p = 250 \mu s$
 $V_{CE} = 24 V$

$T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 18. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,135 \text{ K/W}$

IGBT thermal model values

R (K/W)	τ (s)
9,28E-03	5,97E+00
3,75E-02	1,43E+00
4,26E-02	2,44E-01
3,69E-02	2,77E-02
8,68E-03	1,44E-03

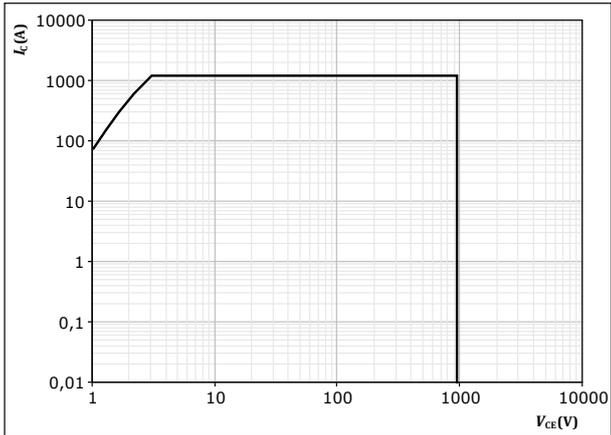


DC-Link Switch Characteristics

figure 19. IGBT

Safe operating area

$I_C = f(V_{CE})$



$D =$ single pulse

$T_s = 80$ °C

$V_{CE} = 15$ V

$T_j = T_{jmax}$



Neutral Point Diode Characteristics

figure 20. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

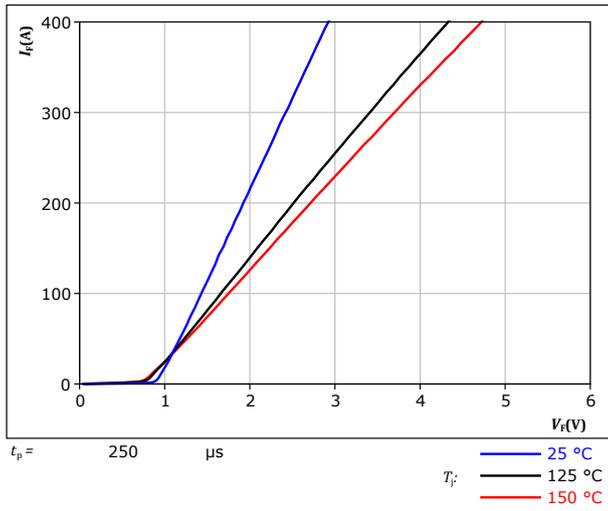
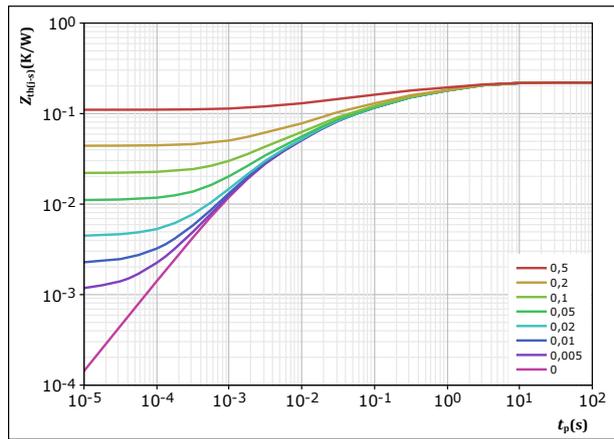


figure 21. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,22$ K/W
 FWD thermal model values

R (K/W)	τ (s)
1,72E-02	5,65E+00
5,85E-02	1,24E+00
6,62E-02	1,43E-01
5,58E-02	1,83E-02
2,27E-02	2,11E-03

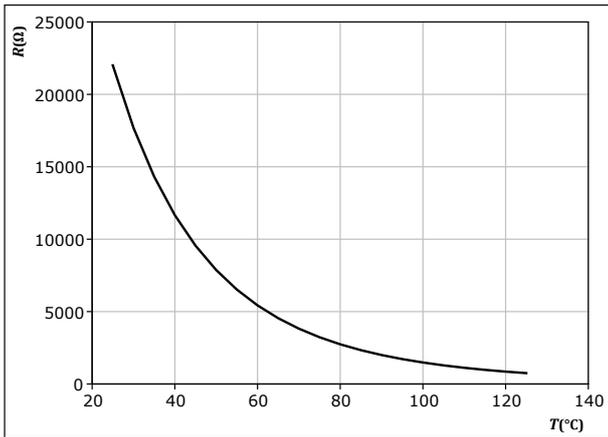


Thermistor Characteristics

figure 22. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

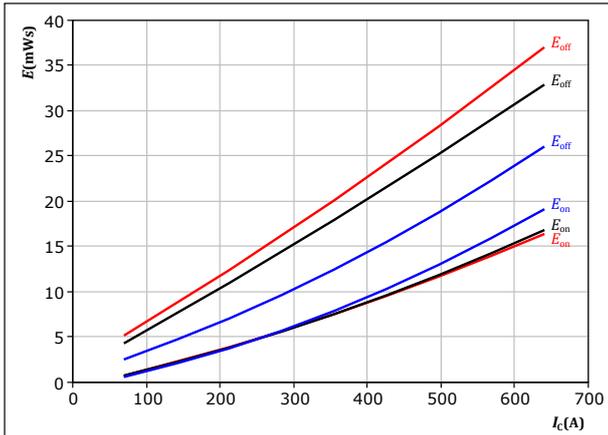




Neutral Point Switching Characteristics

figure 23. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$

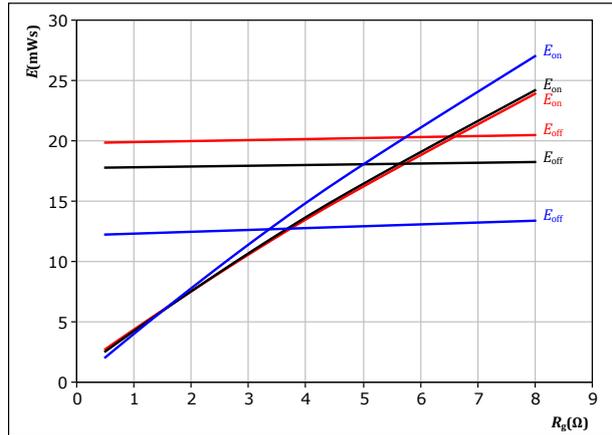


With an inductive load at
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \text{ } \Omega$
 $R_{goff} = 2 \text{ } \Omega$

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 24. IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor
 $E = f(R_g)$

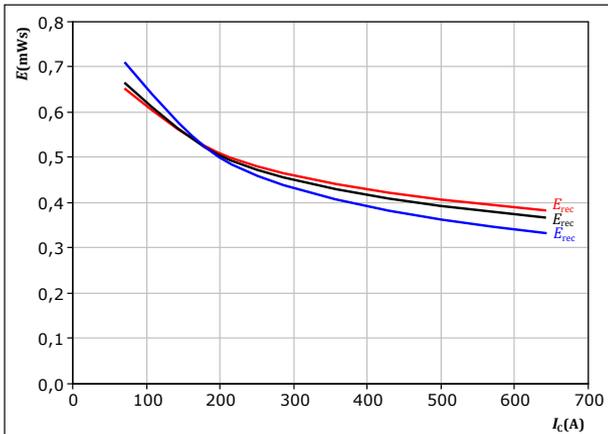


With an inductive load at
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 25. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$

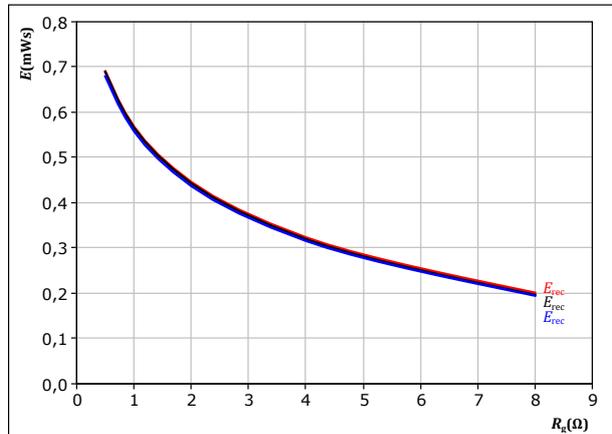


With an inductive load at
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \text{ } \Omega$

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 26. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$

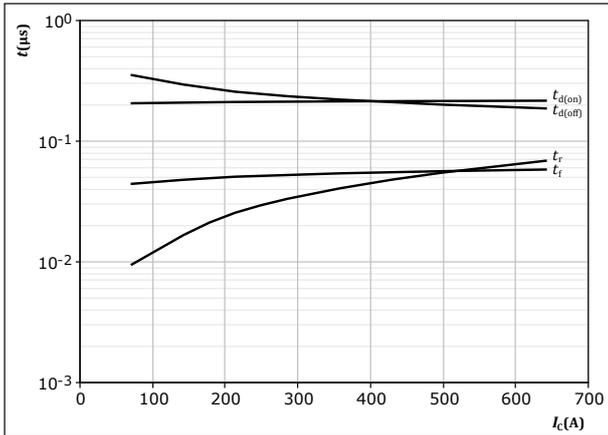
T_j : — 25 °C
 — 125 °C
 — 150 °C



Neutral Point Switching Characteristics

figure 27. IGBT

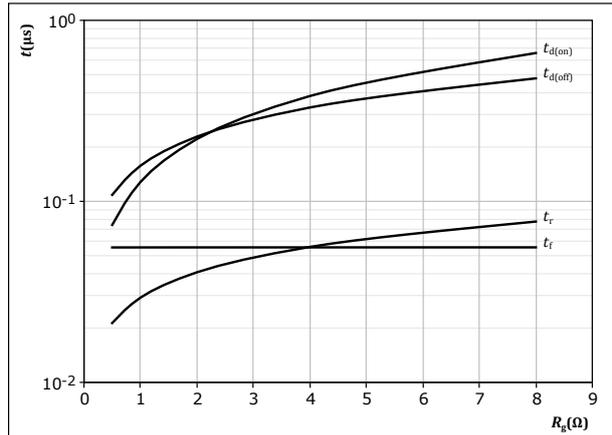
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \text{ } \Omega$
 $R_{goff} = 2 \text{ } \Omega$

figure 28. IGBT

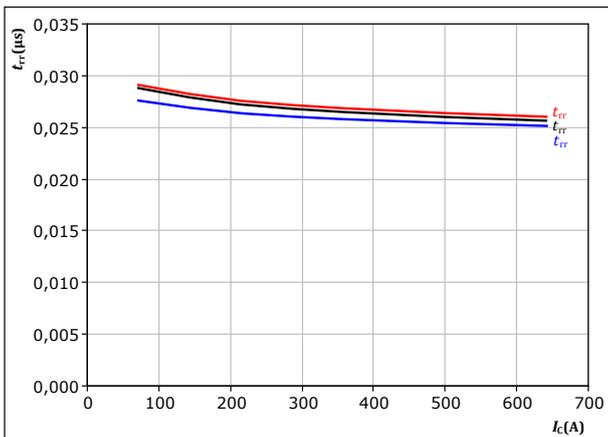
Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$

figure 29. FWD

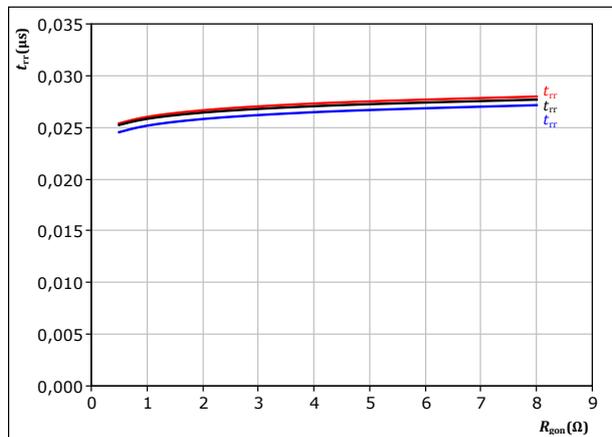
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \text{ } \Omega$
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 30. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

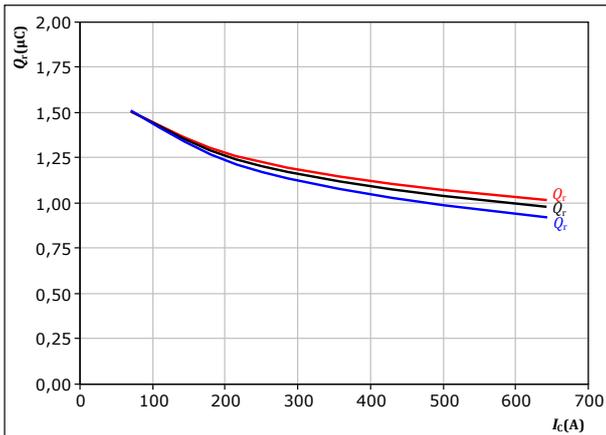


Neutral Point Switching Characteristics

figure 31. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

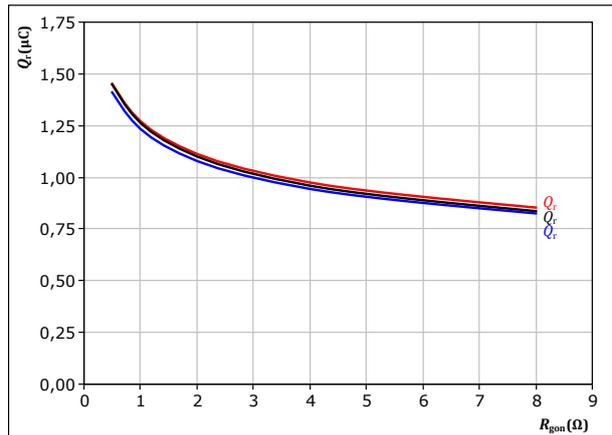
$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \ \Omega$

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 32. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

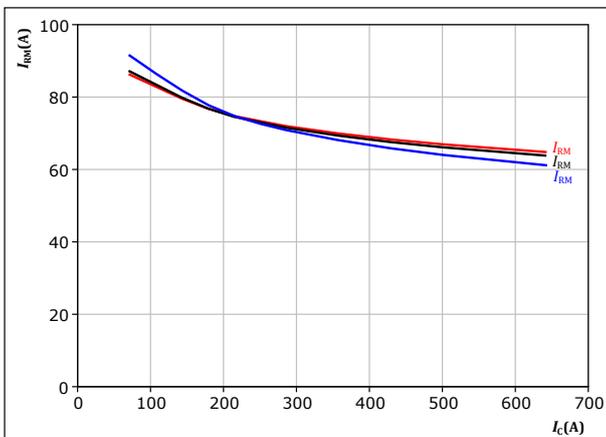
$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 33. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

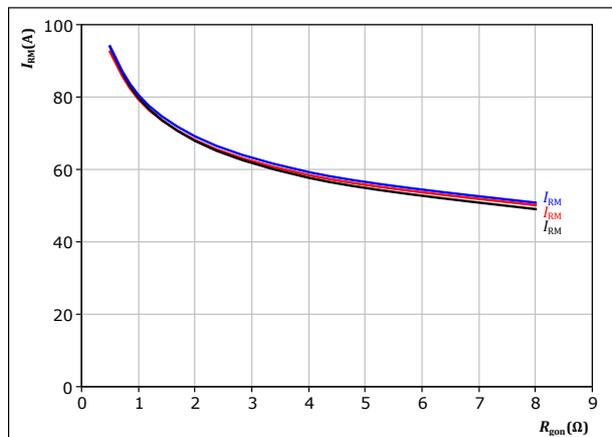
$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \ \Omega$

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 34. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$

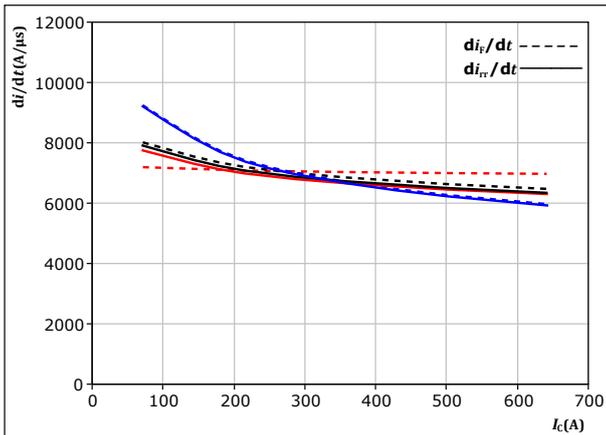
T_j : — 25 °C
 — 125 °C
 — 150 °C



Neutral Point Switching Characteristics

figure 35. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_C)$

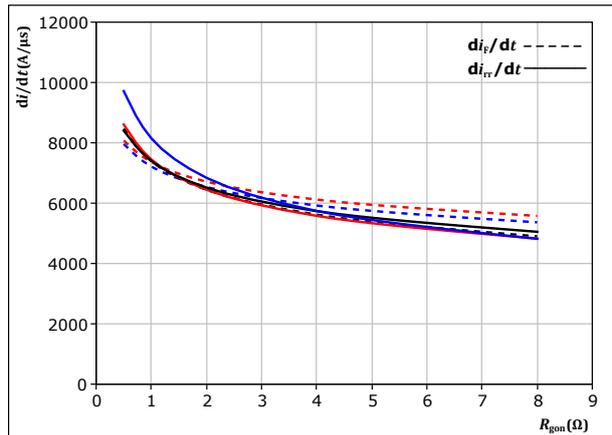


With an inductive load at

$V_{CE} = 600$ V	$T_j = 25$ °C
$V_{GE} = \pm 15$ V	$T_j = 125$ °C
$R_{gon} = 2$ Ω	$T_j = 150$ °C

figure 36. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



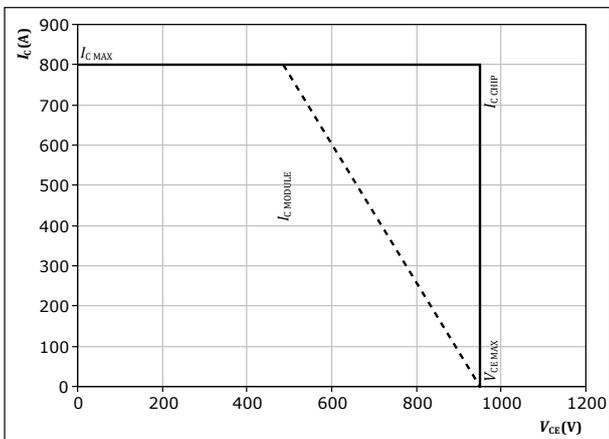
With an inductive load at

$V_{CE} = 600$ V	$T_j = 25$ °C
$V_{GE} = \pm 15$ V	$T_j = 125$ °C
$I_C = 355$ A	$T_j = 150$ °C

figure 37. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



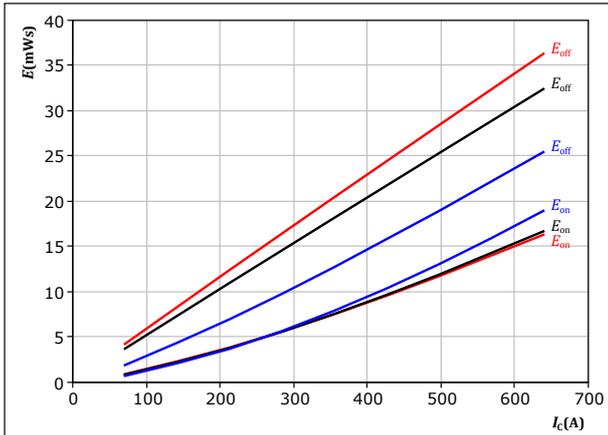
At $T_j = 150$ °C
 $R_{gon} = 2$ Ω
 $R_{goff} = 2$ Ω



DC-Link Switching Characteristics

figure 38. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$



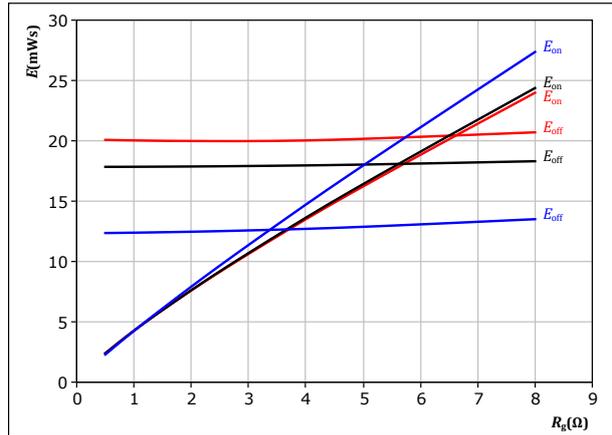
With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \text{ } \Omega$
 $R_{goff} = 2 \text{ } \Omega$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 39. IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor
 $E = f(R_g)$



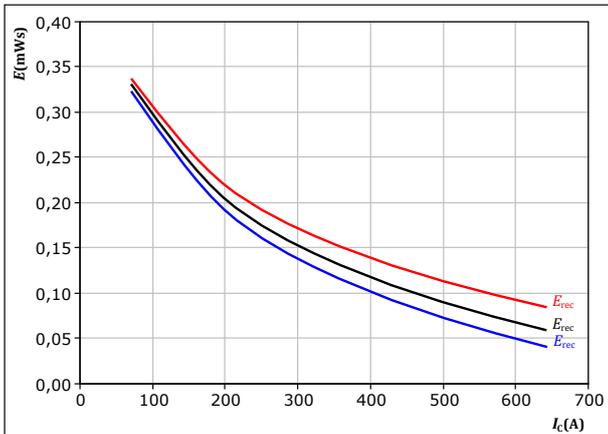
With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 40. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$



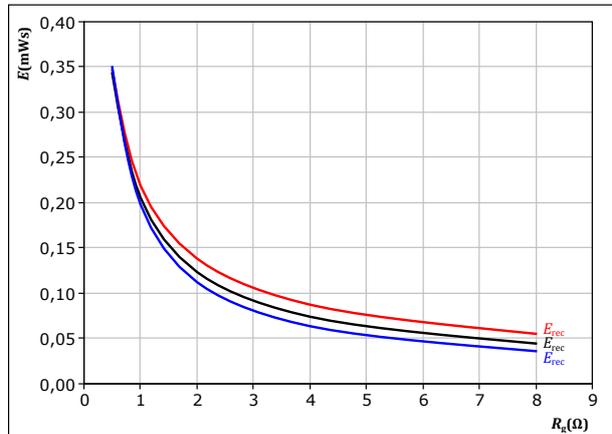
With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \text{ } \Omega$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 41. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$

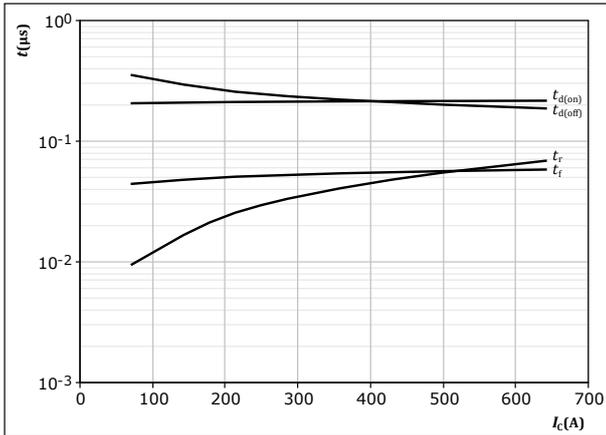
T_j : — 25 °C
— 125 °C
— 150 °C



DC-Link Switching Characteristics

figure 42. IGBT

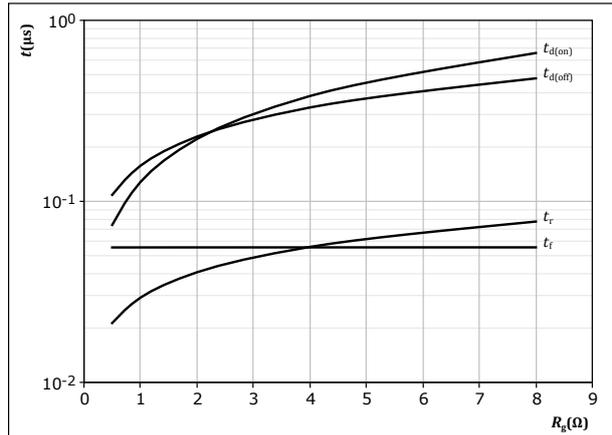
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \text{ } \Omega$
 $R_{goff} = 2 \text{ } \Omega$

figure 43. IGBT

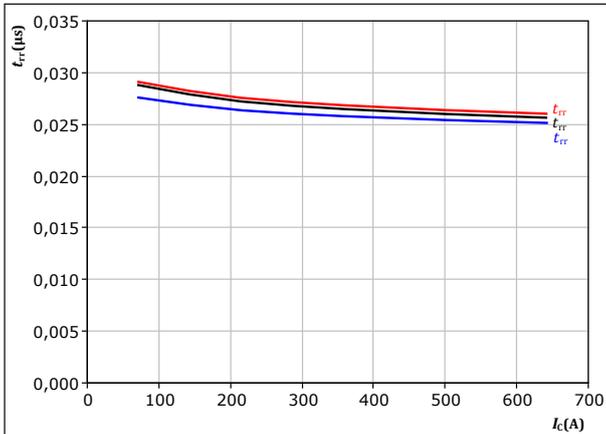
Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$

figure 44. FWD

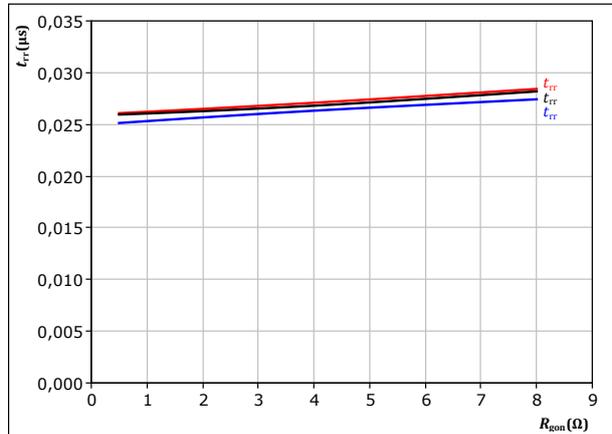
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \text{ } \Omega$
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 45. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

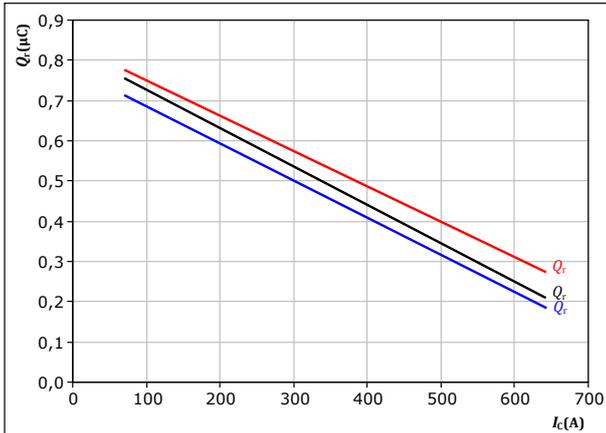


DC-Link Switching Characteristics

figure 46. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

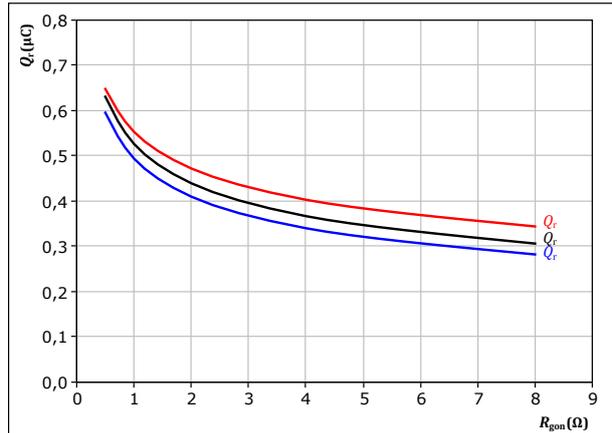
$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \ \Omega$

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 47. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

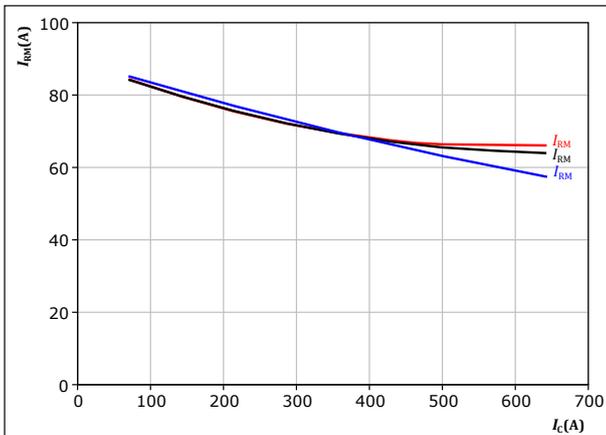
$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 48. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

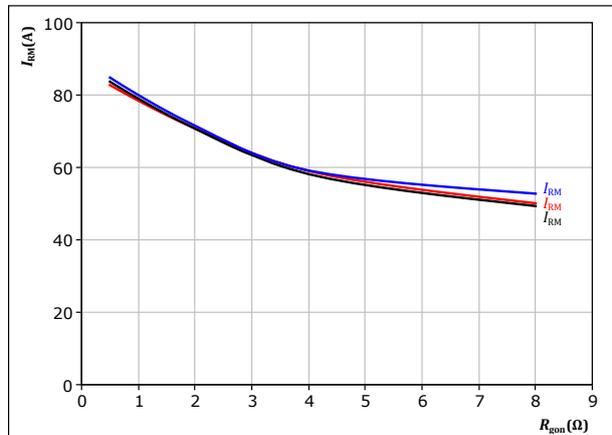
$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \ \Omega$

T_j : — 25 °C
 — 125 °C
 — 150 °C

figure 49. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$

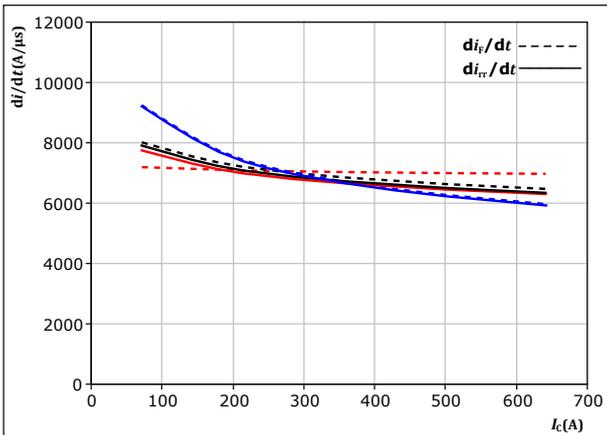
T_j : — 25 °C
 — 125 °C
 — 150 °C



DC-Link Switching Characteristics

figure 50. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$

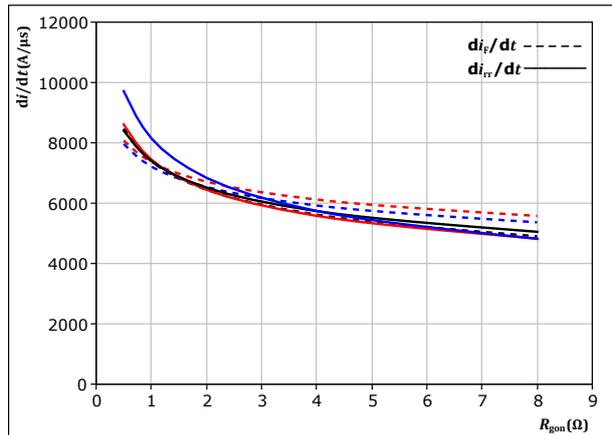


With an inductive load at
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \text{ } \Omega$

T_j :
 — 25 °C
 — 125 °C
 — 150 °C

figure 51. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$

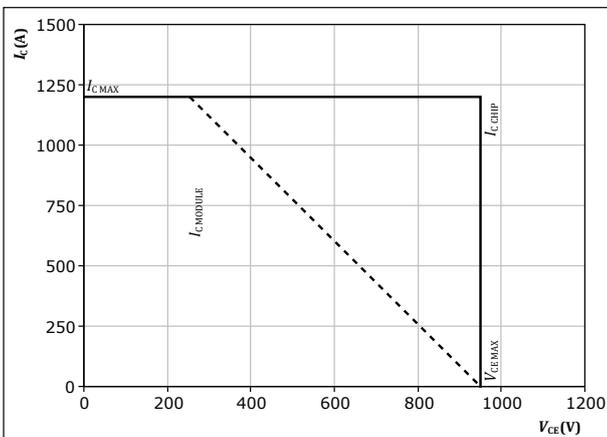


With an inductive load at
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 355 \text{ A}$

T_j :
 — 25 °C
 — 125 °C
 — 150 °C

figure 52. IGBT

Reverse bias safe operating area
 $I_c = f(V_{CE})$



At $T_j = 150 \text{ } ^\circ\text{C}$
 $R_{gon} = 2 \text{ } \Omega$
 $R_{goff} = 2 \text{ } \Omega$



Switching Definitions

figure 53. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

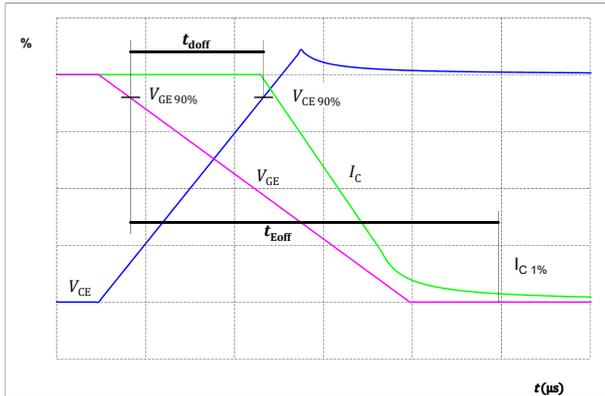


figure 54. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

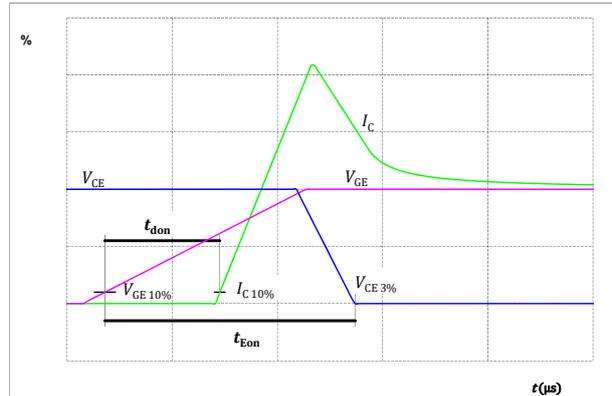


figure 55. IGBT

Turn-off Switching Waveforms & definition of t_f

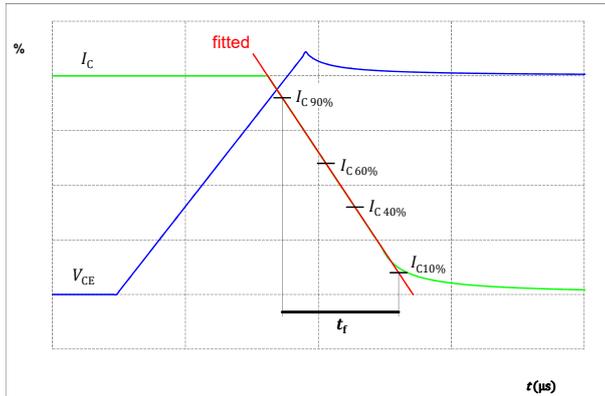
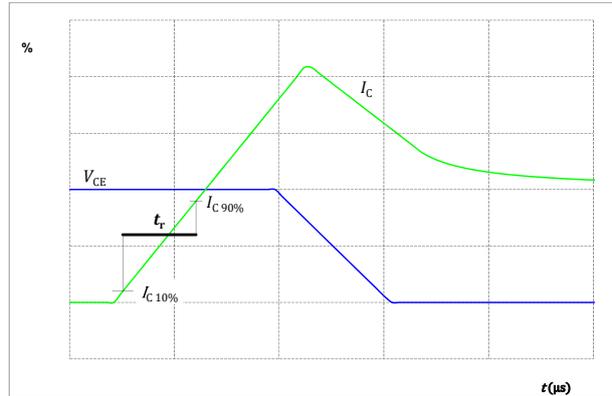


figure 56. IGBT

Turn-on Switching Waveforms & definition of t_r





Switching Definitions

figure 57. FWD

Turn-off Switching Waveforms & definition of t_{rr}

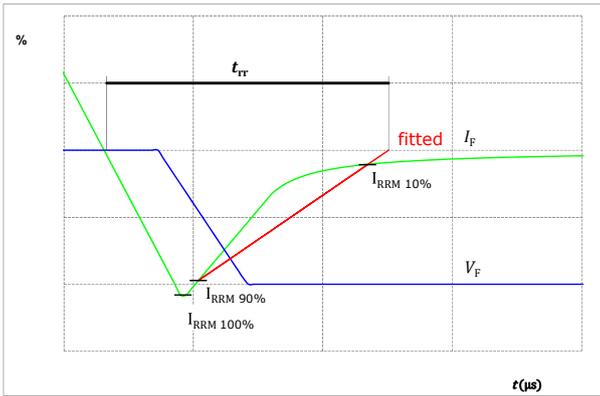
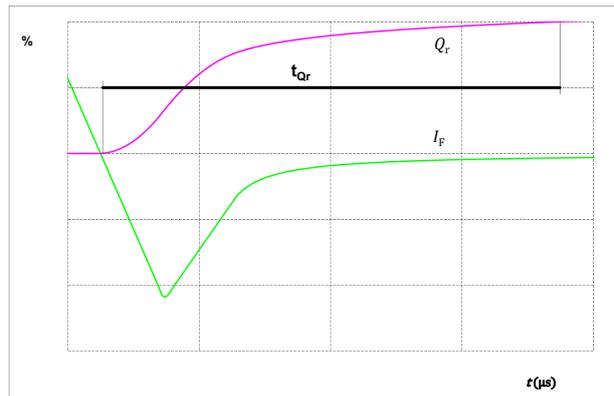


figure 58. FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)



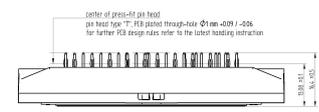
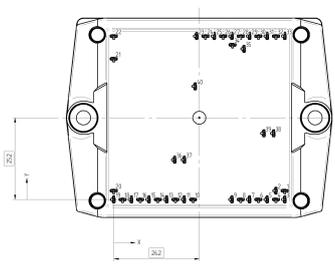


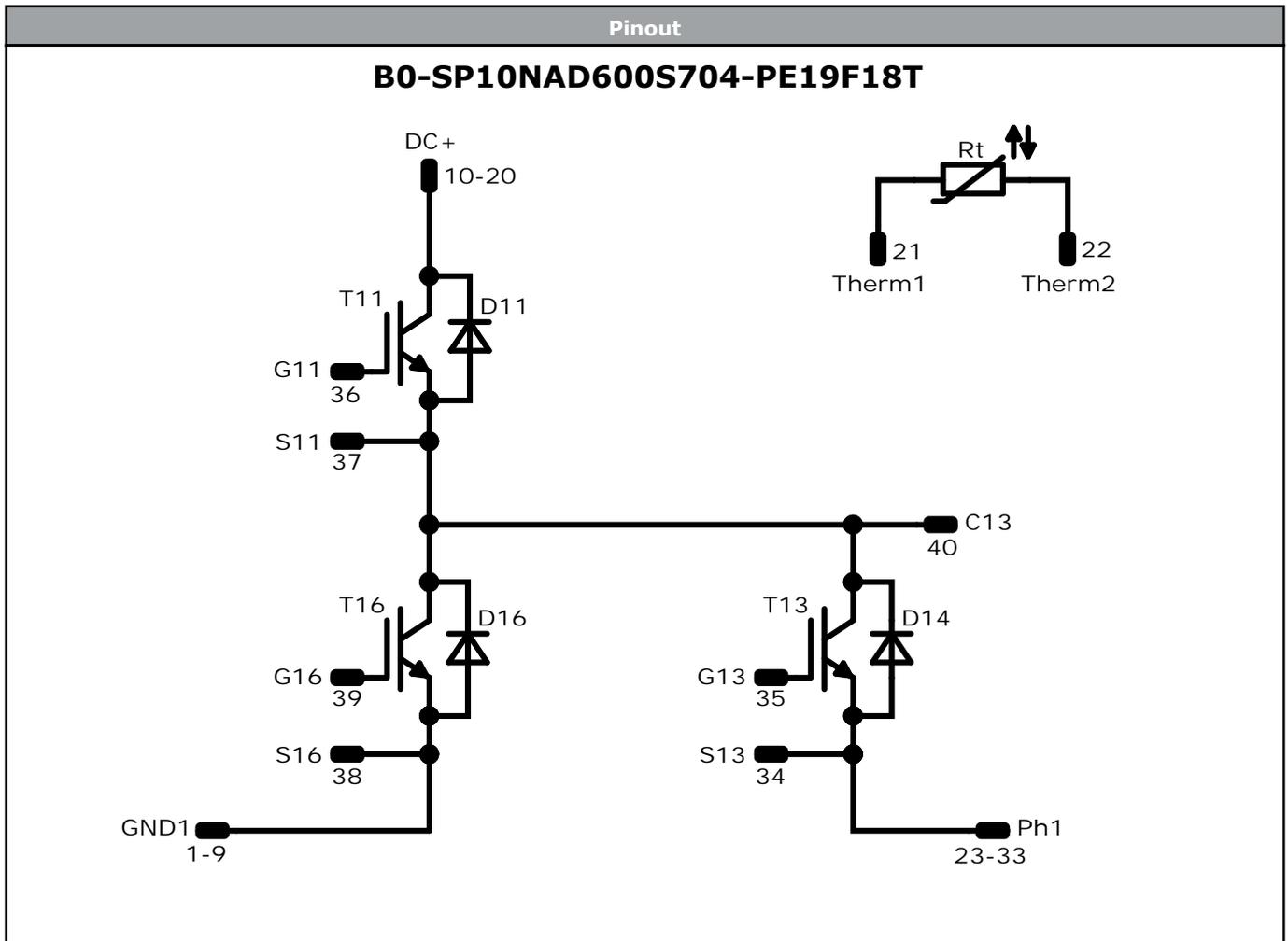
Vincotech

B0-SP10NAD600S704-PE19F18T
B0-SP10NAE600S704-PE29F18T
 datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	B0-SP10NAD600S704-PE19F18T
With thermal paste (5,2 W/mK, PTM6000HV)	B0-SP10NAD600S704-PE19F18T-/7/

Marking						
	Text	Name NN-NNNNNNNNNNNNNN- TTTTTVV	Date code WWYY	UL & VIN UL VIN	Lot LLLLL	Serial SSSS
	Datamatrix	Type&Ver TTTTTTTV	Lot number LLLLL	Serial SSSS	Date code WWYY	

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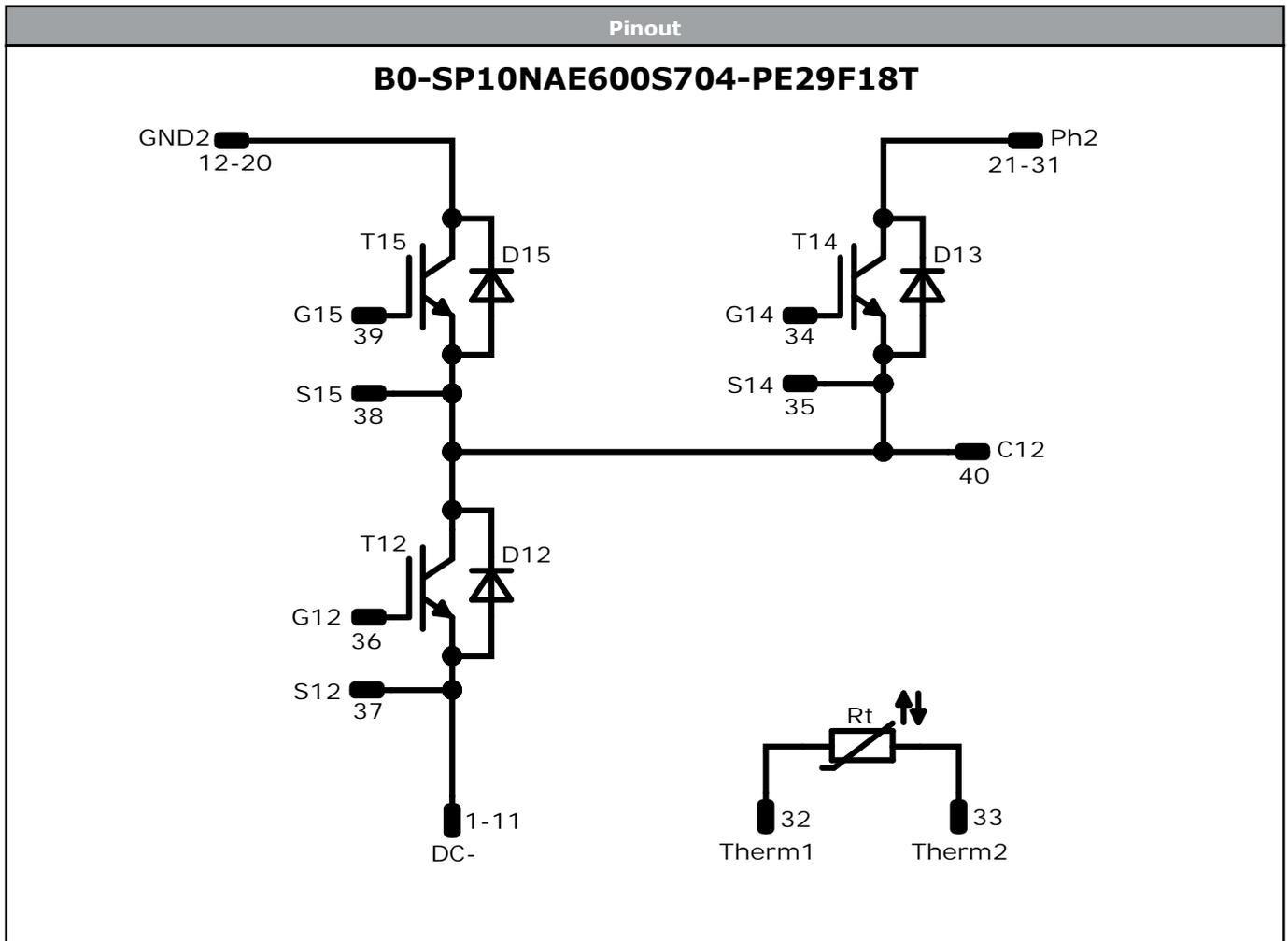
Identification					
ID	Component	Voltage	Current	Function	Comment
T13	IGBT	950 V	400 A	AC Switch	
D14	FWD	950 V	300 A	AC Diode	
T16	IGBT	950 V	400 A	Neutral Point Switch	
D11	FWD	950 V	300 A	DC-Link Diode	
T11	IGBT	950 V	600 A	DC-Link Switch	
D16	FWD	1200 V	160 A	Neutral Point Diode	
Rt	Thermistor			Thermistor	



Ordering Code	
Version	Ordering Code
Without thermal paste	B0-SP10NAE600S704-PE29F18T
With thermal paste (5,2 W/mK, PTM6000HV)	B0-SP10NAE600S704-PE29F18T-/7/

Marking						
	Text	Name	Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNNNNN- TTTTTWWYY LL VIN LLLL SSSS	WWYY	UL VIN	LLLLL	SSSS
Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTTVV	LLLLL	SSSS	WWYY		

Outline				
Pin table [mm]				
Pin	X	Y	Function	
1	52,4	2,7	DC-	<h3 style="text-align: center;">B0-SP10NAE600S704-PE29F18T</h3> <p>center of press-fit pin head pin lead type "T", PCB drilled through-hole Ø1 mm ±0,01 / -0,04 for further PCB design rules refer to the latest handling instruction</p> <p style="font-size: small;">Tolerance of positions: ±50µm at the end of pins Dimension of coordinate axis is only offset without tolerance</p>
2	52,4	0	DC-	
3	49,7	0	DC-	
4	47	0	DC-	
5	44,3	0	DC-	
6	41,6	0	DC-	
7	38,9	0	DC-	
8	36,2	0	DC-	
9	33,5	0	DC-	
10	30,8	0	DC-	
11	28,1	0	DC-	
12	16,2	0	GND2	
13	13,5	0	GND2	
14	10,8	0	GND2	
15	8,1	0	GND2	
16	5,4	0	GND2	
17	2,7	0	GND2	
18	0	0	GND2	
19	2,7	2,7	GND2	
20	0	2,7	GND2	
21	0	50,4	Ph2	
22	2,7	50,4	Ph2	
23	5,4	50,4	Ph2	
24	8,1	50,4	Ph2	
25	10,8	50,4	Ph2	
26	13,5	50,4	Ph2	
27	16,2	50,4	Ph2	
28	18,9	50,4	Ph2	
29	21,6	50,4	Ph2	
30	24,3	50,4	Ph2	
31	27	50,4	Ph2	
32	52,4	50,4	Therm1	
33	52,4	43,4	Therm2	
34	12,5	34,5	G14	
35	16	33,2	S14	
36	46	26,4	G12	
37	49	26,4	S12	
38	23,5	17,5	S15	
39	20,5	17,5	G15	
40	24,85	29,85	C12	



Identification					
ID	Component	Voltage	Current	Function	Comment
T14	IGBT	950 V	400 A	AC Switch	
D13	FWD	950 V	300 A	AC Diode	
T15	IGBT	950 V	400 A	Neutral Point Switch	
D12	FWD	950 V	300 A	DC-Link Diode	
T12	IGBT	950 V	600 A	DC-Link Switch	
D15	FWD	1200 V	160 A	Neutral Point Diode	
Rt	Thermistor			Thermistor	



Packaging instruction				
Standard packaging quantity (SPQ) 45	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow</i> S3 packages see vincotech.com website.

Package data
Package data for <i>flow</i> S3 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is UL 1557 recognized under E192116 up to a junction temperature under switching condition $T_{j,op}=150^{\circ}\text{C}$ and up to 4000VAC/1min isolation voltage. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
B0-SP10NAX600S704-PEX9F18T-D4-14	8 Apr. 2025	Change housing (PCN-2024-006) Remove capacitor (PCN-2025-011)	

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.